



SCHOTTKY BARRIER DIODES

FEATURES

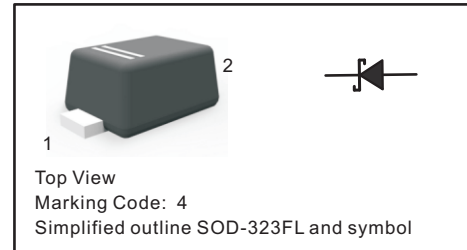
- Guard ring protection
- Low forward voltage drop
- For use in low voltage, high frequency inverters
- Surface mount device type

MECHANICAL DATA

- Case: SOD-323FL
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 4.5mg / 0.00016oz

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | Cathode |
| 2 | Anode |



Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

| Parameter | Symbols | RB501VFL-40 | Units |
|---|-----------|---|---------|
| Maximum recurrent peak reverse voltage | V_{RM} | 45 | V |
| DC reverse voltage | V_R | 40 | V |
| Continuous forward current | I_O | 0.1 | A |
| Reverse Leakage Current | I_R | 30 @ $V_R=10V$ | μA |
| Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load (JEDEC method) | I_{FSM} | 13 | A |
| Maximum Forward Voltage | V_F | 0.34 @ $I_F=10mA$ 0.55 @ $I_F=100mA$ | V |
| Capacitance between terminals $V_R=10V, f=1MHz$ | C_T | 6 | pF |
| Junction Temperature | T_j | 125 | °C |
| Storage Temperature | T_{stg} | -55 ~ +150 | °C |



Fig.1 Derating curve

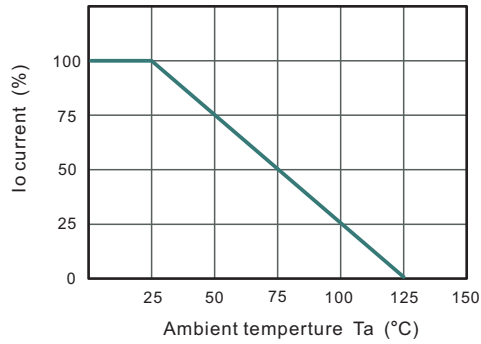


Fig.2 Typical Reverse Characteristics

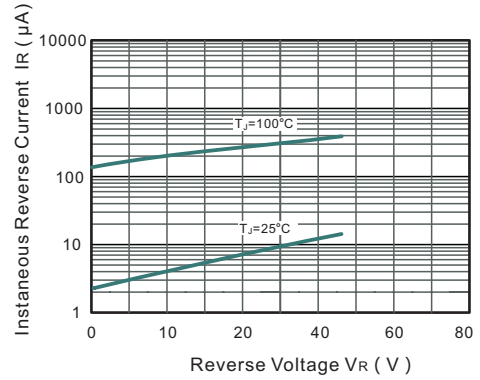


Fig.3 TYPICAL FORWARD VOLTAGE

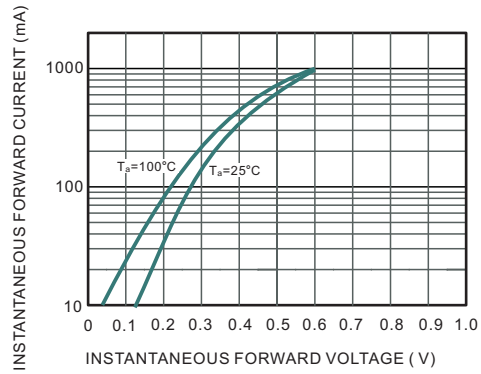


Fig.4 Typical Junction Capacitance

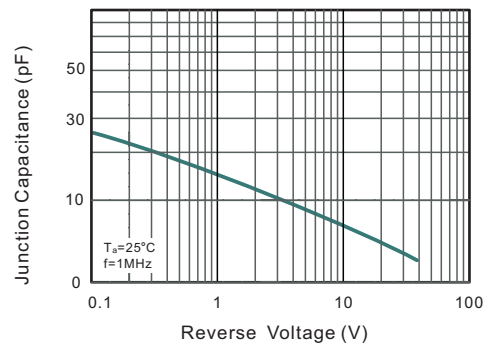
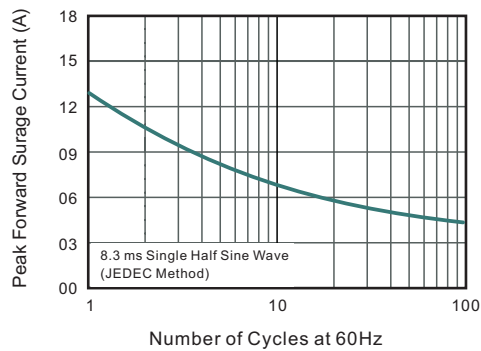


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

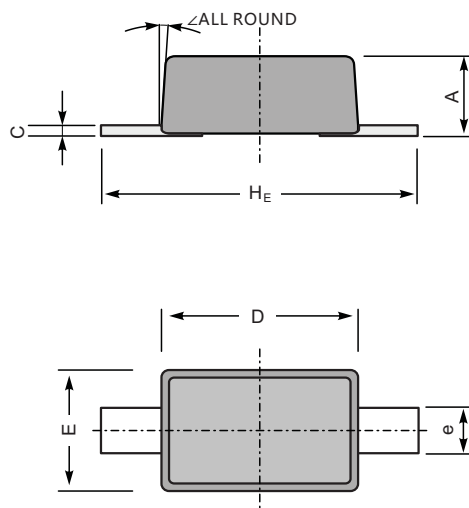




PACKAGE OUTLINE

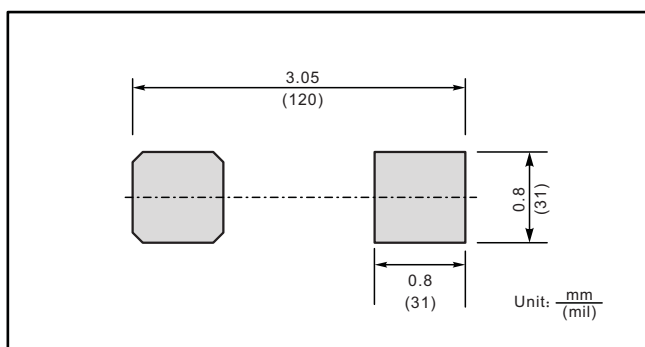
Plastic surface mounted package; 2 leads

SOD-323FL



| UNIT | | A | C | D | E | e | H _E | \angle |
|------|-----|-----|------|-----|------|------|----------------|----------|
| mm | max | 1.0 | 0.25 | 1.8 | 1.35 | 0.4 | 2.7 | 8° |
| | min | 0.8 | 0.05 | 1.6 | 1.15 | 0.25 | 2.3 | |
| mil | max | 39 | 9.8 | 71 | 53 | 18 | 106 | |
| | min | 31 | 2.0 | 63 | 45 | 10 | 91 | |

The recommended mounting pad size



Marking

| Type number | Marking code |
|-------------|--------------|
| RB501VFL-40 | 4 |